

HiPerFET[™]Power MOSFETs ISOPLUS247[™]

IXFR 4N100Q

$V_{DSS} = 1000 V$ $I_{D25} = 3.5 A$

$R_{DS(on)} = 3.0 \Omega$

t_{rr} ≤ 200ns

(Electrically Isolated Backside)

N-Channel Enhancement Mode Avalanche Rated, Low Q_q, High dv/dt

Preliminary Data



Symbol	Test Conditions	Maximum Ratings		
V _{DSS} V _{DGR}	$T_J = 25^{\circ}\text{C} \text{ to } 150^{\circ}\text{C}$ $T_J = 25^{\circ}\text{C} \text{ to } 150^{\circ}\text{C}; R_{GS} = 1 \text{ M}\Omega$	1000 1000	V	
V _{GS}	Continuous Transient	±20 ±30	V V	
I _{D25} I _{DM}	$T_{c} = 25^{\circ}C$ $T_{c} = 25^{\circ}C$, Note 1 $T_{c} = 25^{\circ}C$	3.5 16 4	A A A	
E _{AR} E _{AS}	$T_{c} = 25^{\circ}C$ $T_{c} = 25^{\circ}C$	20 700	mJ mJ	
dv/dt	$\begin{array}{l} I_{_{S}} & \leq I_{_{DM}}, di/dt \leq 100 A/\mu s, V_{_{DD}} \leq V_{_{DSS}} \\ T_{_{J}} & \leq 150^{\circ} C, R_{_{G}} = 2 \Omega \end{array}$	5	V/ns	
P_{D}	T _c = 25°C	80	W	
T _J		-55 + 150	°C	
T _{JM} T _{stg}		150 -55 +150	°C °C	
$\overline{\mathbf{T}_{\!\scriptscriptstyle L}}$	1.6 mm (0.063 in.) from case for 10 s	300	°C	
V _{ISOL}	50/60 Hz, RMS t = 1 min	2500	V~	
Weight		5	g	

E153432	
S	Isolated backside*

G = Gate	D = Drain
S = Source	

^{*} Patent pending

Features

- Silicon chip on Direct-Copper-Bond substrate
- High power dissipation
- Isolated mounting surface
- 2500V electrical isolation
- Low drain to tab capacitance(<30pF)
- $^{\bullet} \ \mathsf{Low} \ \mathsf{R}_{^{\mathsf{DS}} \ \mathsf{(on)}} \ \mathsf{HDMOS^{\mathsf{TM}}} \ \mathsf{process}$
- Rugged polysilicon gate cell structure
- Rated for Unclamped Inductive Load Switching (UIS)
- Fast intrinsic Rectifier

Symbol	Test Conditions	$(T_J = 25^{\circ}C, \text{ unless of } $	ristic Values se specified) max.
V _{DSS}	V _{GS} = 0 V, I _D = 1mA	1000	V
V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 1.5 \text{ mA}$	3.0	5.0 V
I _{GSS}	$V_{GS} = \pm 20 V_{DC}, V_{DS} = 0$		±100 nA
I _{DSS}	$V_{DS} = V_{DSS}$ $V_{GS} = 0 V$	$T_J = 25^{\circ}C$ $T_J = 125^{\circ}C$	50 μA 1 mA
R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_{D} = I_{T}$		3.0 Ω

Applications

- DC-DC converters
- Battery chargers
- Switched-mode and resonant-mode power supplies
- DC choppers
- AC motor control

Advantages

- Easy assembly
- Space savings
- High power density

Notes 2, 3



Symbol	Test Conditions	(T _J = 25°C, 1			istic Values se specified) max.
g_{fs}	$V_{DS} = 10 \text{ V}; I_{D} = I_{T}$	Notes 2, 3	1.5	2.5	S
C _{iss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25$	V, f = 1 MHz		1050 120	pF pF
C _{rss}) GS DS	,		30	pF
t _{d(on)} t _r t _{d(off)}	$\begin{cases} V_{GS} = 10 \text{ V}, V_{DS} = 0. \\ R_{G} = 2 \Omega \text{ (External)}, \end{cases}$	200 2 .		17 15 32 18	ns ns ns
$egin{aligned} egin{aligned} egin{aligned\\ egin{aligned} egi$	$\begin{cases} V_{GS} = 10 \text{ V}, V_{DS} = 0. \\ \text{Notes } 2, 3 \end{cases}$	$5 \bullet V_{DSS}, I_{D} = I_{T}$		39 9 22	nC nC nC
R _{thJC}					1.57 K/W
R _{thCK}				0.15	K/W

Source-Drain Diod	_

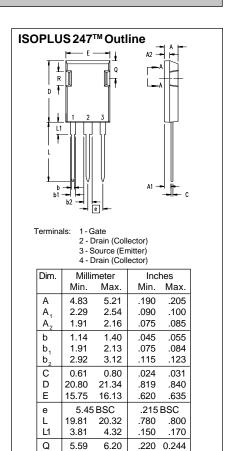
Characteristic Values

 $(T_{J} = 25^{\circ}C, \text{ unless otherwise specified})$

Symbol	Test Conditions n	nin.	typ.	max.	
I _s	V _{GS} = 0 V			4	Α
I _{SM}	Repetitive; Note 1			16	Α
V _{SD}	$I_{F} = I_{S}, V_{GS} = 0 \text{ V, Notes } 2, 3$			1.5	V
t _{rr})			250	ns
$\mathbf{Q}_{_{\mathbf{RM}}}$	$I_{\rm F} = 50 \text{A}, -\text{di/dt} = 100 \text{ A/}\mu\text{s}, V_{\rm R} = 100 \text{ V}$		0.52		μС
I _{RM}) I _F = 307, 31/4t = 100 74 pts, 7 _R = 100 7		1.8		Α

Note: 1. Pulse width limited by T $_{\text{JM}}$ 2. Pulse test, t \leq 300 μ s, duty cycle d \leq 2 %

3. $I_T = 2 A$



See IXFH4N100Q data sheet for Characterisitic curves.

4.83

.170

.190

4.32

R



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